Supplier Name:	
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# Texas Instruments Inc. (DUNS# 00-732-1904) ti.com/support Distribute - RoHS and IEC 62474 DB

06/05/2022

## Details for "SN74ABT841ADBR"

Current Product Information

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package   Pins	Package body size (mm)	Total device mass (mg)*
SN74ABT841ADBR	NIPDAU	Level-1-260C-UNLIM	TI MALAYSIA A/T	DB   24	8.5x5.3x2	227.1

\*Total Device Mass

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

**Environmental Ratings Information** 

RoHS	REACH	Green	IEC 62474 DB
Yes	Yes	Yes	Yes

## **Component Information**

				Homogeneous Material Level		Component Level	
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm
Bond Wire							
Copper and Its Alloys	Copper	7440-50-8	0.113555	99.997358	999974	0.050002	500
Copper and Its Alloys	Iron	7439-89-6	0.000001	0.000881	9	0	0
Precious Metals	Silver	7440-22-4	0.000002	0.001761	18	0.000001	0
Sub-Total			0.113558	100	1000000	0.050004	500
Die Attach Adhesive							
Precious Metals	Silver	7440-22-4	0.693119	79.999977	800000	0.305205	3052
Thermoplastics	Epoxy	85954-11-6	0.17328	20.000023	200000	0.076301	763
Sub-Total			0.866399	100	1000000	0.381506	3815
Lead Frame							
Copper and Its Alloys	Copper	7440-50-8	53.489007	98.67	986700	23.553113	235531
Other Nonferrous Metals and Alloys	Chromium	7440-47-3	0.16263	0.3	3000	0.071612	716
Other Nonferrous Metals and Alloys	Tin	7440-31-5	0.146367	0.27	2700	0.064451	645
Precious Metals	Silver	7440-22-4	0.27105	0.5	5000	0.119353	1194
Zinc and Its Alloys	Zinc	7440-66-6	0.140946	0.26	2600	0.062064	621
Sub-Total			54.21	100	1000000	23.870592	238706
Lead Frame Plating							
Nickel and Its Alloys	Nickel	7440-02-0	5.022336	95.12	951200	2.211513	22115
Precious Metals	Gold	7440-57-5	0.041184	0.78	7800	0.018135	181
Precious Metals	Palladium	7440-05-3	0.21648	4.1	41000	0.095324	953
Sub-Total			5.28	100	1000000	2.324972	23250
Mold Compound							
Other Inorganic Materials	Fused Silica	60676-86-0	144.13869	88	880000	63.469394	634694
Other Plastics and Rubber	Carbon Black	1333-86-4	0.491382	0.3	3000	0.216373	2164
Other Plastics and Rubber	Organic Phosphorus	1330-78-5	0.900867	0.55	5500	0.396684	3967
Thermoplastics	Epoxy	85954-11-6	18.263027	11.15	111500	8.041861	80419
Sub-Total			163.793966	100	1000000	72.124312	721243
Semiconductor Device							
Ceramics / Glass	Doped Silicon	7440-21-3	2.835598	100	1000000	1.248615	12486
Sub-Total			2.835598	100	1000000	1.248615	12486
Total			227.099521			100	1000000

### Important Note

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm

for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component. The ppm calculations are at the **component** level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the **component**. See Glossary of Terms for more details.

#### Important Part Information

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSIs or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

Product Content Methodology

For an explanation of the methods used to determine material weights, See Product Content Methodology

#### Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

#### Important Information/Disclaimer

Ti bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is."

# For additional information, please contact TI customer support.

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 06/05/2022

RoHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

RoHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szzq088

Green: Means the content of Chlorine (CI) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (Sb203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.